

01-22-2001

PTO-1595

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To the Honorable Commissioner of Patents and Trademarks, please record the attached original documents or copy thereof.

1 Name of conveying party(ies):

Bao-Ru Young
Kun-I Lee
Der-Fang Huang

3 Nature of conveyance:

Assignment Merger

Security Agreement Change of Name

Other:
Execution Date: December 4, 2000

2 Name and address of receiving party(ies):

Taiwan Semiconductor Manufacturing Co. Ltd.
No. 121 Park Avenue 3
Science-Based Industrial Park
Hsin-Chu, Taiwan, R.O.C.

Additional name(s) & address(es) attached Yes No

9/756026

JC675 U.S. PTO
09/756026
01/05/01

4 Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 12-04-00

A. Patent Application No(s). B. Patent No(s)

Additional numbers attached? Yes No

5 Name and address of party to whom correspondence concerning document should be mailed:

RANDY W. TUNG
Tung & Associates
838 W. Long Lake Road
Suite 120
Bloomfield Hills, Michigan 48302

6 Total number of applications and patents involved: 1

7 Total fee (37 CFR 3.41) **\$40.00**

Enclosed

Authorized to be charged to deposit account

8 Deposit Account Number: 50-0484

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9 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Randy W. Tung [Signature] January 4, 2001
Name of Person Signing Signature Date
Registration No. 31,311

Total number of pages including cover sheet, attachments, and document : 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

67,200-342

PATENT
REEL: 011434 FRAME: 0776

ASSIGNMENT

WHEREAS, we, BAO-RU YOUNG, KUN-I LEE and DER-FANG HUANG have invented certain improvements in METHOD FOR SPIN COATING A HIGH VISCOSITY LIQUID ON A WAFER for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, BAO-RU YOUNG, KUN-I LEE and DER-FANG HUANG, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 4th day of December, 2000, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or

continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

Bao-Ru Young

BAO-RU YOUNG

KUN-I LEE

KUN-I LEE

Der-Fang Huang

DER-FANG HUANG

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